

74VHCT245AFT

1. Functional Description

- Octal Bus Transceiver

2. General

The 74VHCT245AFT is an advanced high speed CMOS OCTAL BUS TRANSCEIVER fabricated with silicon gate C²MOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It is intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (\overline{G}) can be used to disable the device so that the busses are effectively isolated.

The input voltage are compatible with TTL output voltage.

This device may be used as a level converter for interfacing 3.3 V to 5 V system.

Input protection and output circuit ensure that 0 V to 5.5 V can be applied to the input and output (**Note**) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, etc.

Note: Output in off-state

3. Features (Note)

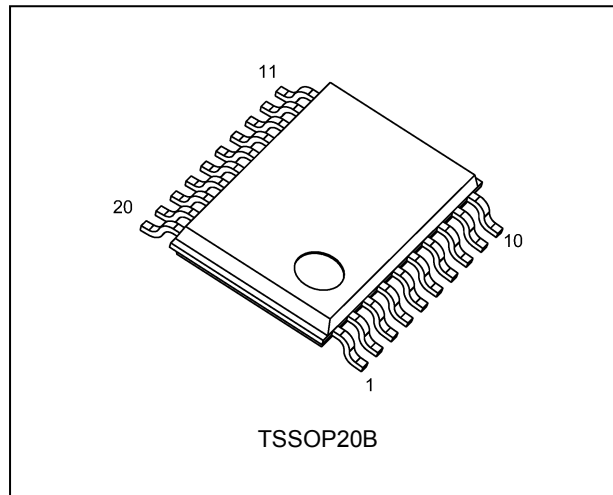
- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature : $T_{opr} = -40\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$
- (3) High speed: Propagation delay time = 4.9 ns (typ.) at $V_{CC} = 5.0\text{ V}$
- (4) Quiescent supply current: $I_{CC} = 4.0\text{ }\mu\text{A}$ (max) at $T_a = 25\text{ }^{\circ}\text{C}$
- (5) Compatible with TTL inputs: $V_{IL} = 0.8\text{ V}$ (max)
 $V_{IH} = 2.0\text{ V}$ (min)
- (6) Power-down protection is provided on all inputs and outputs
- (7) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (8) Low noise: $V_{OLP} = 1.5\text{ V}$ (max)
- (9) Pin and function compatible with the 74 series (74ACT/HCT/AHCT etc.) 245 type.

Note: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.
All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

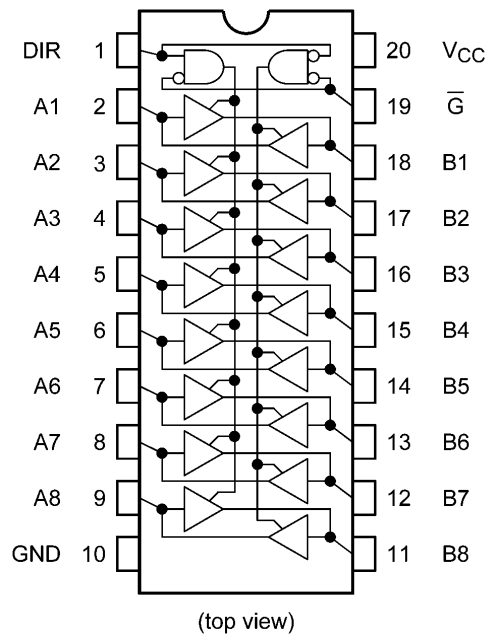
Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

Start of commercial production
2013-01

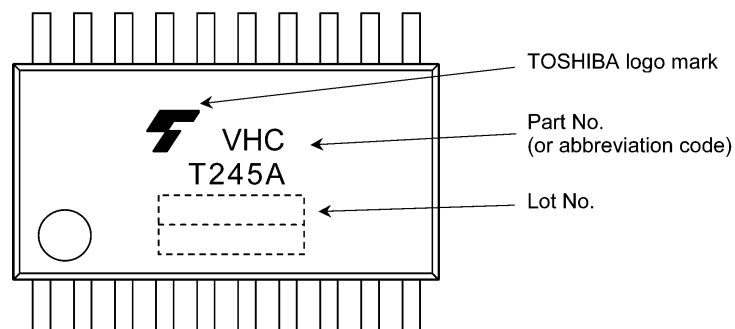
4. Packaging



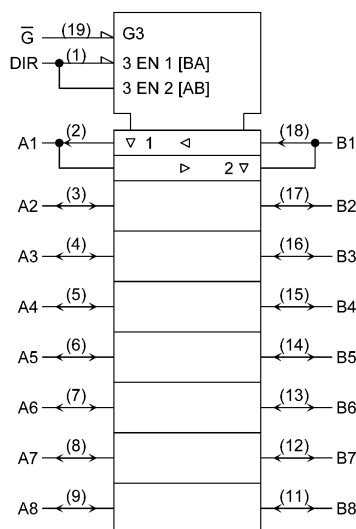
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

Input \bar{G}	Input DIR	A BUS	B BUS	Output
L	L	Output	Input	A = B
L	H	Input	Output	B = A
H	X	Z	Z	Z

X: Don't care
Z: High impedance

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage(DIR, \bar{G})	V_{IN}		-0.5 to 7.0	V
Bus I/O voltage	$V_{I/O}$	(Note 1)	-0.5 to 7.0	V
		(Note 2)	-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}		-20	mA
Output diode current	I_{OK}	(Note 3)	± 20	mA
Output current	I_{OUT}		± 25	mA
V_{CC} /ground current	I_{CC}		± 75	mA
Power dissipation	P_D	(Note 4)	180	mW
Storage temperature	T_{stg}		-65 to 150	$^{\circ}C$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in off-state

Note 2: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Note 4: 180 mW in the range of $T_a = -40$ to $85^{\circ}C$. From $T_a = 85$ to $125^{\circ}C$ a derating factor of -3.25 mW/ $^{\circ}C$ shall be applied until 50 mW.

10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		4.5 to 5.5	V
Input voltage(DIR,G)	V_{IN}		0 to 5.5	V
Bus I/O voltage	$V_{I/O}$	(Note 1)	0 to 5.5	V
		(Note 2)	0 to V_{CC}	V
Operating temperature	T_{opr}		-40 to 125	°C
Input rise and fall times	dt/dv		0 to 20	ns/V

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note 1: Output in off-state

Note 2: High or low state

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Typ.	Max	Unit	
High-level input voltage	V_{IH}	—	4.5 to 5.5	2.0	—	—	V	
Low-level input voltage	V_{IL}	—	4.5 to 5.5	—	—	0.8	V	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50\ \mu\text{A}$	4.5	4.4	4.5	—	V
			$I_{OH} = -8\ \text{mA}$	4.5	3.94	—	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50\ \mu\text{A}$	4.5	—	0.0	0.1	V
			$I_{OL} = 8\ \text{mA}$	4.5	—	—	0.36	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND	5.5	—	—	± 0.25	μA	
Input leakage current	I_{IN}	$V_{IN} = 5.5\ \text{V}$ or GND	0 to 5.5	—	—	± 0.1	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	5.5	—	—	4.0	μA	
Quiescent supply current	I_{CCT}	Per input: $V_{IN} = 3.4\ \text{V}$, other input: V_{CC} or GND	5.5	—	—	1.35	mA	
Output leakage current (Power-OFF)	I_{OPD}	$V_{OUT} = 5.5\ \text{V}$	0	—	—	0.5	μA	

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit	
High-level input voltage	V_{IH}	—	4.5 to 5.5	2.0	—	V	
Low-level input voltage	V_{IL}	—	4.5 to 5.5	—	0.8	V	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50\ \mu\text{A}$	4.5	4.4	—	V
			$I_{OH} = -8\ \text{mA}$	4.5	3.80	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50\ \mu\text{A}$	4.5	—	0.1	V
			$I_{OL} = 8\ \text{mA}$	4.5	—	0.44	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND	5.5	—	± 2.50	μA	
Input leakage current	I_{IN}	$V_{IN} = 5.5\ \text{V}$ or GND	0 to 5.5	—	± 1.0	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	5.5	—	40.0	μA	
Quiescent supply current	I_{CCT}	Per input: $V_{IN} = 3.4\ \text{V}$, other input: V_{CC} or GND	5.5	—	1.50	mA	
Output leakage current (Power-OFF)	I_{OPD}	$V_{OUT} = 5.5\ \text{V}$	0	—	5.0	μA	

11.3. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit	
High-level input voltage	V_{IH}	—	4.5 to 5.5	2.0	—	V	
Low-level input voltage	V_{IL}	—	4.5 to 5.5	—	0.8	V	
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50 \mu A$	4.5	4.4	—	V
			$I_{OH} = -8 \text{ mA}$	4.5	3.70	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50 \mu A$	4.5	—	0.1	V
			$I_{OL} = 8 \text{ mA}$	4.5	—	0.55	
3-state output OFF-state leakage current	I_{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND	5.5	—	± 10.0	μA	
Input leakage current	I_{IN}	$V_{IN} = 5.5 \text{ V}$ or GND	0 to 5.5	—	± 2.0	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	5.5	—	80.0	μA	
Quiescent supply current	I_{CCT}	Per input: $V_{IN} = 3.4 \text{ V}$ Other input: V_{CC} or GND	5.5	—	1.50	mA	
Output leakage current (Power-OFF)	I_{OPD}	$V_{OUT} = 5.5 \text{ V}$	0	—	± 20.0	μA	

11.4. AC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Typ.	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}		—	5.0 ± 0.5	15	—	4.9	7.7	ns
					50	—	5.4	8.7	
3-state output enable time	t_{PZL}, t_{PZH}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	15	—	9.4	13.8	ns
					50	—	9.9	14.8	
3-state output disable time	t_{PLZ}, t_{PHZ}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	50	—	10.1	15.4	ns
Output skew	t_{osLH}, t_{osHL}	(Note 1)	—	5.0 ± 0.5	50	—	—	1.0	ns
Input capacitance	C_{IN}		DIR, \overline{G}			—	4	10	pF
Bus I/O capacitance	$C_{I/O}$		A_n, B_n			—	13	—	pF
Power dissipation capacitance	C_{PD}	(Note 2)	—			—	16	—	pF

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLHM} - t_{PLHN}|$, $t_{osHL} = |t_{PHLM} - t_{PHLN}|$)

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per bit)}$$

11.5. AC Characteristics (Unless otherwise specified, $T_a = -40\text{ to }85\text{ }^\circ\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}		—	5.0 ± 0.5	15	1.0	8.5	ns
					50	1.0	9.5	
3-state output enable time	t_{PZL}, t_{PZH}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	15	1.0	15.0	ns
					50	1.0	16.0	
3-state output disable time	t_{PLZ}, t_{PHZ}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	50	1.0	16.5	ns
Output skew	t_{osLH}, t_{osHL}	(Note 1)	—	5.0 ± 0.5	50	—	1.0	ns
Input capacitance	C_{IN}		DIR, \overline{G}			—	10	pF

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLHM} - t_{PLHN}|$, $t_{osHL} = |t_{PHLM} - t_{PHLN}|$)

11.6. AC Characteristics (Unless otherwise specified, $T_a = -40\text{ to }125\text{ }^\circ\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}		—	5.0 ± 0.5	15	1.0	10.0	ns
					50	1.0	11.0	
3-state output enable time	t_{PZL}, t_{PZH}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	15	1.0	17.0	ns
					50	1.0	17.5	
3-state output disable time	t_{PLZ}, t_{PHZ}		$R_L = 1\text{ k}\Omega$	5.0 ± 0.5	50	1.0	18.0	ns
Output skew	t_{osLH}, t_{osHL}	(Note 1)	—	5.0 ± 0.5	50	—	1.0	ns
Input capacitance	C_{IN}		DIR, \overline{G}			—	10	pF

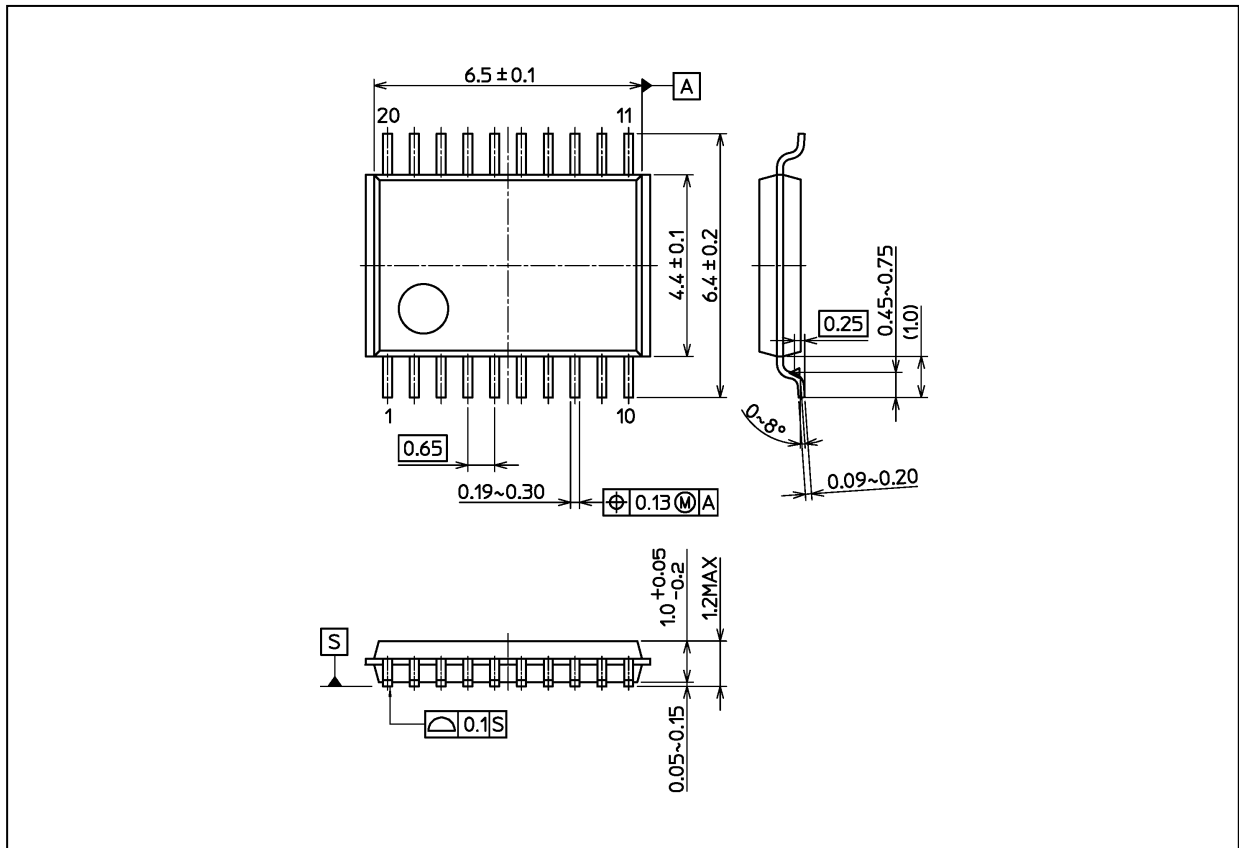
Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLHM} - t_{PLHN}|$, $t_{osHL} = |t_{PHLM} - t_{PHLN}|$)

11.7. Noise Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$, Input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Typ.	Limit	Unit
Quiet output maximum dynamic V_{OL}	V_{OLP}	$C_L = 50\text{ pF}$	5.0	1.1	1.5	V
Quiet output minimum dynamic V_{OL}	V_{OLV}	$C_L = 50\text{ pF}$	5.0	-1.1	-1.5	V
Minimum high-level dynamic input voltage	V_{IHD}	$C_L = 50\text{ pF}$	5.0	—	2.0	V
Maximum low-level dynamic input voltage	V_{ILD}	$C_L = 50\text{ pF}$	5.0	—	0.8	V

Package Dimensions

Unit: mm



Weight: 0.071 g (typ.)

Package Name(s)
Nickname: TSSOP20B

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